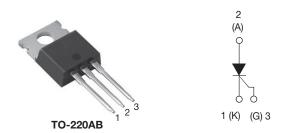


VS-25TTS...PbF Series, VS-25TTS...-M3 Series

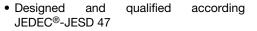
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Thyristor High Voltage, Phase Control SCR, 25 A



PRIMARY CHARACTERISTICS					
I _{T(AV)} 16 A					
V _{DRM} /V _{RRM}	800 V, 1200 V				
V _{TM}	1.25 V				
I _{GT}	45 mA				
TJ	-40 °C to 125 °C				
Package	TO-220AB				
Circuit configuration	Single SCR				

FEATURES





• 125 °C max. operating junction temperature

 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

 Typical usage is in input rectification crowbar (soft start) and AC switch in motor control, UPS, welding, and battery charge.

DESCRIPTION

The VS-25TTS... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS							
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS							
Capacitive input filter T _A = 55 °C, T _J = 125 °C, common heatsink of 1 °C/W	18	22	А				

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
I _{T(AV)}	Sinusoidal waveform	16	А			
I _{RMS}		25	A			
V _{RRM} /V _{DRM}		800/1200	V			
I _{TSM}		320	Α			
V _T	16 A, T _J = 25 °C	1.25	V			
dV/dt		500	V/μs			
dI/dt		150	A/μs			
TJ		-40 to 125	°C			

VOLTAGE RATINGS						
PART NUMBER	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA				
VS-25TTS08PbF, VS-25TTS08-M3	800	800	10			
VS-25TTS12PbF, VS-25TTS12-M3	1200	1200	10			



VS-25TTS...PbF Series, VS-25TTS...-M3 Series

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ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CO.	NDITIONS	VAL	UNITS		
PARAMETER	SYMBOL TEST CONDITIONS		RIDITIONS	TYP.	MAX.	JOINITS	
Maximum average on-state current	I _{T(AV)}	T _C = 93 °C, 180° conduc	tion half sine wave	1	6		
Maximum RMS on-state current	I _{RMS}			2	5	A	
Maximum peak, one-cycle,	L	10 ms sine pulse, rated \	V _{RRM} applied	2	70		
non-repetitive surge current	I _{TSM}	10 ms sine pulse, no volt	tage reapplied	3	20		
Maximum I ² t for fusing	I ² t	10 ms sine pulse, rated \	V _{RRM} applied	365		A ² s	
Maximum i-t for fusing	I-ι	10 ms sine pulse, no volt	515		7 A-S		
Maximum $I^2\sqrt{t}$ for fusing	I²√t	t = 0.1 to 10 ms, no volta	ge reapplied	5152		A²√s	
Maximum on-state voltage drop	V_{TM}	16 A, T _J = 25 °C			25	V	
On-state slope resistance	r _t	T 405.00			2.0	mΩ	
Threshold voltage	V _{T(TO)}	T _J = 125 °C		1	.0	V	
Maximum reverse and direct leakage current	1/1	T _J = 25 °C	V Potod V //	0	.5		
Maximum reverse and direct leakage current	I_{RM}/I_{DM}	$V_R = Rated V_{RRM}/V_{DRM}$		1	0		
Holding current	l _Η	Anode supply = 6 V, resistive load, initial I_T = 1 A, T_J = 25 °C		-	150	mA	
Maximum latching current	l∟	Anode supply = 6 V, resistive load, T_J = 25 °C			00		
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear to } 80$	$^{\circ}$ C, $V_{DRM} = R_g - k = Open$	pen 500		V/µs	
Maximum rate of rise of turned-on current	dl/dt			150		A/µs	

TRIGGERING	TRIGGERING						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum peak gate power	P _{GM}		8.0	w			
Maximum average gate power	P _{G(AV)}		2.0	VV			
Maximum peak positive gate current	+ I _{GM}		1.5	Α			
Maximum peak negative gate voltage	- V _{GM}		10	V			
	I _{GT}	Anode supply = 6 V, resistive load, T _J = - 10 °C	60				
Maximum required DC gate current to trigger		Anode supply = 6 V, resistive load, T _J = 25 °C	45	mA			
		Anode supply = 6 V, resistive load, T _J = 125 °C	20				
		Anode supply = 6 V, resistive load, T _J = - 10 °C	2.5				
Maximum required DC gate voltage to trigger	V_{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	2.0	v			
voltage to trigger		Anode supply = 6 V, resistive load, T _J = 125 °C	1.0	V			
Maximum DC gate voltage not to trigger	$V_{\sf GD}$	T 105 % V Detectively	0.25				
Maximum DC gate current not to trigger	I _{GD}	T _J = 125 °C, V _{DRM} = Rated value	2.0	mA			

SWITCHING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Typical turn-on time	t _{gt}	T _J = 25 °C	0.9		
Typical reverse recovery time	t _{rr}	T _J = 125 °C	4	μs	
Typical turn-off time	t _q	1	110		



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THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	1	T_J, T_Stg		-40 to 125	°C
Maximum thermal resistance, junction to case		R_{thJC}	DC operation	1.1	
Maximum thermal resistance, junction to ambient		R _{thJA}		62	°C/W
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.5	
Approximate weight				2	g
Approximate weight				0.07	OZ.
Mauration to record				6 (5)	kgf · cm
Mounting torque -	maximum			12 (10)	(lbf · in)
Marking device			Consistua TO 220AB	25TTS08	
			Case style TO-220AB		ΓS12

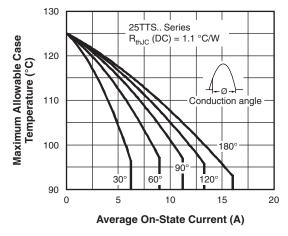


Fig. 1 - Current Rating Characteristics

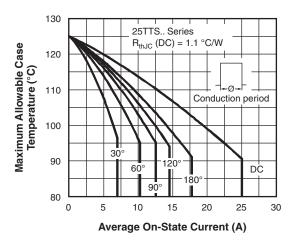


Fig. 2 - Current Rating Characteristics

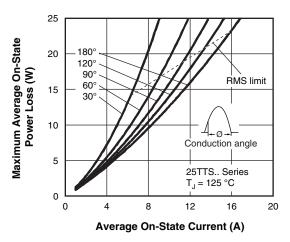


Fig. 3 - On-State Power Loss Characteristics

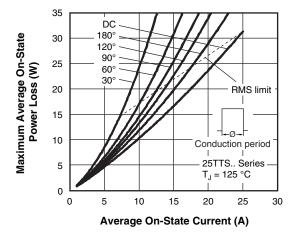


Fig. 4 - On-State Power Loss Characteristics

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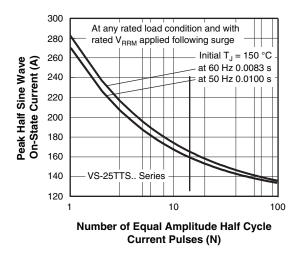


Fig. 5 - Maximum Non-Repetitive Surge Current

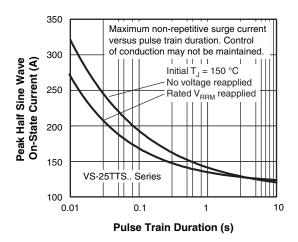


Fig. 6 - Maximum Non-Repetitive Surge Current

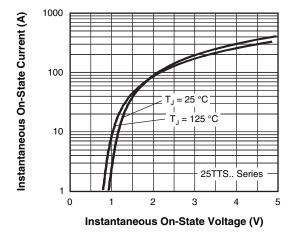


Fig. 7 - On-State Voltage Drop Characteristics

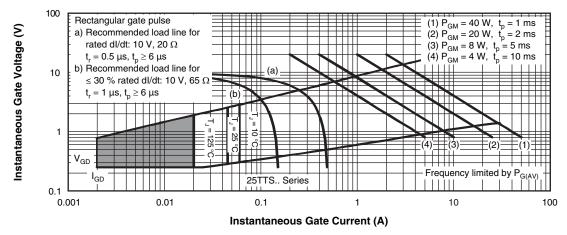


Fig. 8 - Gate Characteristics

VS-25TTS...PbF Series, VS-25TTS...-M3 Series

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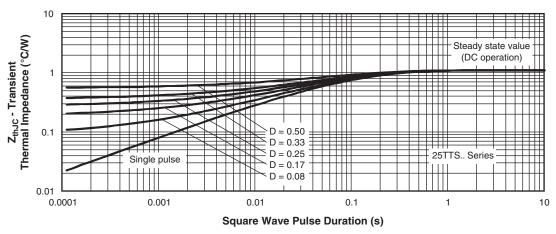


Fig. 9 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

Device code	VS-	25	Т	Т	s	12	PbF	
	1	2	3	4	5	6	7	ı
	1 - 2 - 3 - 4 - 5	Curro Circo T = Pac T = Typ S =	rent rational rent rational rent rational rent rational rent rent rational rent rent rational rent rent rational rent rent rent rent rent rent rational rent rent rent rent rent rent rent rent	ng (25 = iguration hyristor AB con:	,		I .	3 = 800 V
	7		age rati ronmen	ng —— tal digit:			12	= 1200 V
		PbF	= Lead	(Pb)-fre	e and R	oHS co	mpliant	

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-25TTS08PbF	50	1000	Antistatic plastic tubes			
VS-25TTS08-M3	50	1000	Antistatic plastic tubes			
VS-25TTS12PbF	50	1000	Antistatic plastic tubes			
VS-25TTS12-M3	50	1000	Antistatic plastic tubes			

-M3 = Halogen-free, RoHS compliant, and terminations lead (Pb)-free

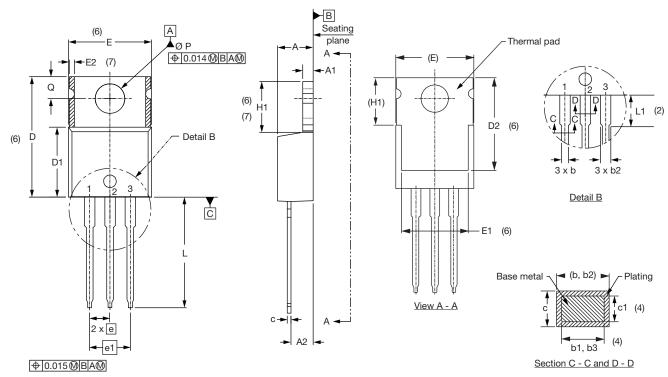
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95222</u>					
Dort marking information	TO-220AB PbF	www.vishay.com/doc?95225			
Part marking information	TO-220AB -M3	www.vishay.com/doc?95028			



Vishay Semiconductors

TO-220AB

DIMENSIONS in millimeters and inches



Lead assignments

Diodes

- 1. Anode/open
- 2. Cathode
- 3. Anode

Conforms to JEDEC outline TO-220AB

SYMBOL	MILLIN	IETERS	HES	NOTES	
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOIES
E	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
е	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
ØΡ	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	
θ	90° to 93°		90° to 93°		
		•	•	•	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline

Lead tip



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